

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of)	Attorney Docket No.: MIYOSH0006
)	
Kazuyoshi TENDOU et al.)	Confirmation No. 5987
)	
Serial No.: 10/596,387)	Group Art Unit: 1796
)	
Filed: April 13, 2007)	Examiner: M. J. Feely
)	
For: EPOXY RESIN MOLDING)	Date: September 16, 2009
MATERIAL FOR SEALING AND		
ELECTRONIC COMPONENT		

INFORMATION DISCLOSURE STATEMENT

MAIL STOP: Amendment

United States Patent and Trademark Office
Customer Service Window
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

In accordance with the duty of disclosure as set forth in 37 C.F.R. §1.56, this Information Disclosure Statement in connection with the above-identified application is being filed in accordance with 37 C.F.R. §1.97(c).

The document identified on Form PTO/SB/08A was cited in the present specification. Its relevance is believed to be clear from the specification. Accordingly, no further comment regarding the disclosure of this document is believed to be required. A copy of the non-U.S. document identified on the attached Form PTO/SB/08A is attached.

It is respectfully requested that the attached document be considered and officially cited, and that the Examiner initial a copy of Form PTO/SB/08A, and return it to the undersigned to indicate that the document has been considered.

The requisite fee of \$180.00 is attached herewith. It is believed that the present Information Disclosure Statement complies with the requirements of 37 C.F.R. § 1.97-8, but the Director is hereby authorized to charge any additional fees to Deposit Account No. 50-1281.

Respectfully submitted,

GRIFFIN & SZIPL, PC



Joerg-Uwe Szimpl
Registration No. 31,799

GRIFFIN & SZIPL, PC
Suite PH-1
2300 Ninth Street, South
Arlington, VA 22204

Telephone: (703) 979-5700
Facsimile: (703) 979-7429
Email: gands@szipl.com
Customer No.: 24203